

# STW55NM60N

N-channel 600 V, 0.047 Ω, 51 A, MDmesh™ II Power MOSFET TO-247

## Features

| Туре       | V <sub>DSS</sub><br>(@Tjmax) | R <sub>DS(on)</sub><br>max | I <sub>D</sub> |
|------------|------------------------------|----------------------------|----------------|
| STW55NM60N | 650 V                        | < 0.060 Ω                  | 51 A           |

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

## Application

Switching applications

## Description

This series of devices is designed using the second generation of MDmesh<sup>™</sup> technology. This revolutionary Power MOSFET associates a new vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.



| Order code | Marking  | Package | Packaging |
|------------|----------|---------|-----------|
| STW55NM60N | W55NM60N | TO-247  | Tube      |

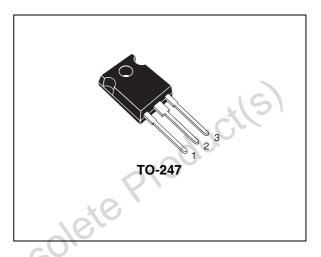
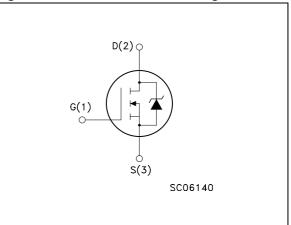


Figure 1.

e 1. Internal schematic diagram



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### **Electrical ratings** 1

| Table 2. | Absolute | maximum | ratings |
|----------|----------|---------|---------|
|          | Aboult   | maximum | radings |

| Symbol                                                                                                                                                     | Parameter                                            | Value      | Unit |  |  |  |
|------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------|------------|------|--|--|--|
| V <sub>DS</sub>                                                                                                                                            | Drain-source voltage (V <sub>GS</sub> = 0)           | 600        | V    |  |  |  |
| V <sub>GS</sub>                                                                                                                                            | Gate- source voltage                                 | ±25        | V    |  |  |  |
| I <sub>D</sub>                                                                                                                                             | Drain current (continuous) at $T_C = 25^{\circ}C$    | 51         | Α    |  |  |  |
| Ι <sub>D</sub>                                                                                                                                             | Drain current (continuous) at T <sub>C</sub> = 100°C | 32         | Α    |  |  |  |
| I <sub>DM</sub> <sup>(1)</sup>                                                                                                                             | Drain current (pulsed)                               | 204        | А    |  |  |  |
| P <sub>TOT</sub>                                                                                                                                           | Total dissipation at $T_{C} = 25^{\circ}C$           | 350        | w    |  |  |  |
| dv/dt <sup>(2)</sup>                                                                                                                                       | Peak diode recovery voltage slope                    | 15         | V/ns |  |  |  |
| T <sub>stg</sub>                                                                                                                                           | Storage temperature                                  | -55 to 150 | °C   |  |  |  |
| Тj                                                                                                                                                         | Max. operating junction temperature                  | 150        | °C   |  |  |  |
| 1. Pulse width limited by safe operating area<br>2. $I_{SD} \le 51$ A, di/dt $\le 400$ A/µs, $V_{DD} = 80\%$ V <sub>(BR)DSS</sub><br>Table 3. Thermal data |                                                      |            |      |  |  |  |
| Symbol                                                                                                                                                     | Parameter                                            | Value      | Unit |  |  |  |

### Table 3. Thermal data

| Symbol         | Parameter                                         | Value | Unit |
|----------------|---------------------------------------------------|-------|------|
| Rthj-case      | Thermal resistance junction-case max              | 0.36  | °C/W |
| Rthj-amb       | Thermal resistance junction-ambient max           | 50    | °C/W |
| Τ <sub>Ι</sub> | Maximum lead temperature for soldering<br>purpose | 300   | °C   |

#### Table 4. Avalanche characteristics

|        | Table 4.        | Avaianche characteristics                                                                               |       |      |
|--------|-----------------|---------------------------------------------------------------------------------------------------------|-------|------|
| 10     | Symbol          | Parameter                                                                                               | Value | Unit |
| 01501c | I <sub>AS</sub> | Avalanche current, repetitive or not-repetitive (pulse width limited by $T_j$ max)                      | 15    | A    |
| 00     | E <sub>AS</sub> | Single pulse avalanche energy<br>(starting $T_j = 25 \text{ °C}, I_D = I_{AS}, V_{DD} = 50 \text{ V}$ ) | 1600  | mJ   |



#### 2 **Electrical characteristics**

(T<sub>CASE</sub>=25°C unless otherwise specified)

| Symbol                                                | Parameter                                                | Test conditions                                                          | Min. | Тур.  | Max.  | Unit     |
|-------------------------------------------------------|----------------------------------------------------------|--------------------------------------------------------------------------|------|-------|-------|----------|
| V <sub>(BR)DSS</sub>                                  | Drain-source<br>breakdown voltage                        | $I_D = 1mA, V_{GS} = 0$                                                  | 600  |       |       | ۷        |
| dv/dt <sup>(1)</sup>                                  | Drain source voltage slope                               | V <sub>DD</sub> = 480 V, I <sub>D</sub> = 51 A,<br>V <sub>GS</sub> =10 V |      | 30    |       | V/ns     |
| I <sub>DSS</sub>                                      | Zero gate voltage<br>drain current (V <sub>GS</sub> = 0) | V <sub>DS</sub> = Max rating<br>V <sub>DS</sub> = Max rating, @125 °C    |      |       | 100   | μΑ<br>μΑ |
| I <sub>GSS</sub>                                      | Gate-body leakage<br>current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ± 20 V                                                 | 6    |       | 100   | nA       |
| V <sub>GS(th)</sub>                                   | Gate threshold voltage                                   | $V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$                                   | 2    | 3     | 4     | V        |
| R <sub>DS(on)</sub>                                   | Static drain-source on resistance                        | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25.5 A                          |      | 0.047 | 0.060 | Ω        |
| 1. Characteristic value at turn off on inductive load |                                                          |                                                                          |      |       |       |          |
| Table 6.                                              | Dynamic                                                  | 0/02                                                                     |      |       |       |          |

#### Table 5. **On/off states**

|        |                                                          | Dynamic                                                                    |                                                                                                               |      |                   |      |                |
|--------|----------------------------------------------------------|----------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------|------|-------------------|------|----------------|
|        | Symbol                                                   | Parameter                                                                  | Test conditions                                                                                               | Min. | Тур.              | Max. | Unit           |
|        | 9 <sub>fs</sub> <sup>(1)</sup>                           | Forward transconductance                                                   | $V_{DS}$ =15 V <sub>,</sub> I <sub>D</sub> = 25.5 A                                                           |      | 45                |      | S              |
|        | C <sub>iss</sub><br>C <sub>oss</sub><br>C <sub>rss</sub> | Input capacitance<br>Output capacitance<br>Reverse transfer<br>capacitance | V <sub>DS</sub> = 50 V, f = 1 MHz,<br>V <sub>GS</sub> = 0                                                     |      | 5800<br>300<br>30 |      | pF<br>pF<br>pF |
| 10     | C <sub>oss eq.</sub> <sup>(2)</sup>                      | Equivalent output capacitance                                              | $V_{GS} = 0, V_{DS} = 0$ to 480 V                                                                             |      | 900               |      | pF             |
| 010501 | Q <sub>g</sub><br>Q <sub>gs</sub><br>Q <sub>gd</sub>     | Total gate charge<br>Gate-source charge<br>Gate-drain charge               | $V_{DD} = 480 \text{ V}, \text{ I}_{D} = 51 \text{ A},$<br>$V_{GS} = 10 \text{ V},$<br><i>(see Figure 15)</i> |      | 190<br>30<br>90   |      | nC<br>nC<br>nC |
|        | Rg                                                       | Gate input resistance                                                      | f=1 MHz gate DC bias=0<br>Test signal level = 20 mV<br>open drain                                             |      | 2.5               |      | Ω              |

#### Table 6. Dvnamic

1. Pulsed: Pulse duration = 300  $\mu s,$  duty cycle 1.5 %

2.  $C_{oss\ eq.}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DS}$ 



|                                                                               | ownering times                                                      |                                                                                                                                   |      |                       |      |                      |
|-------------------------------------------------------------------------------|---------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|------|-----------------------|------|----------------------|
| Symbol                                                                        | Parameter                                                           | Test conditions                                                                                                                   | Min. | Тур.                  | Max. | Unit                 |
| t <sub>d(on)</sub><br>t <sub>r</sub><br>t <sub>d(off)</sub><br>t <sub>f</sub> | Turn-on delay time<br>Rise time<br>Turn-off delay time<br>Fall time | $V_{DD} = 300 \text{ V}, \text{ I}_{D} = 25.5 \text{ A}$<br>$R_{G} = 4.7 \Omega \text{ V}_{GS} = 10 \text{ V}$<br>(see Figure 14) |      | 40<br>30<br>225<br>70 |      | ns<br>ns<br>ns<br>ns |

Table 7. Switching times

### Table 8. Source drain diode

| Symbol                                             | Parameter                                             | Test conditions                                  | Min | Тур. | Max       | Unit   |
|----------------------------------------------------|-------------------------------------------------------|--------------------------------------------------|-----|------|-----------|--------|
| I <sub>SD</sub><br>I <sub>SDM</sub> <sup>(1)</sup> | Source-drain current<br>Source-drain current (pulsed) |                                                  |     | ~    | 51<br>204 | A<br>A |
| V <sub>SD</sub> <sup>(2)</sup>                     | Forward on voltage                                    | $I_{SD} = 25.5 \text{ A}, V_{GS} = 0$            |     | 10   | 1.3       | V      |
| t <sub>rr</sub>                                    | Reverse recovery time                                 | I <sub>SD</sub> = 51 A, di/dt = 100 A/μs         |     | 600  |           | ns     |
| Q <sub>rr</sub>                                    | Reverse recovery charge                               | V <sub>DD</sub> = 100 V                          |     | 15   |           | μC     |
| I <sub>RRM</sub>                                   | Reverse recovery current                              | (see Figure 16)                                  | ð   | 51   |           | А      |
| t <sub>rr</sub>                                    | Reverse recovery time                                 | I <sub>SD</sub> = 51 A, di/dt = 100 A/μs         |     | 750  |           | ns     |
| Q <sub>rr</sub>                                    | Reverse recovery charge                               | V <sub>DD</sub> = 100 V, T <sub>j</sub> = 150 °C |     | 18   |           | μC     |
| I <sub>RRM</sub>                                   | Reverse recovery current                              | (see Figure 16)                                  |     | 51   |           | А      |

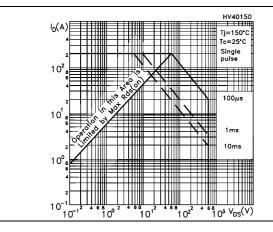
1. Pulse width limited by safe operating area

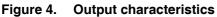
2. Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %

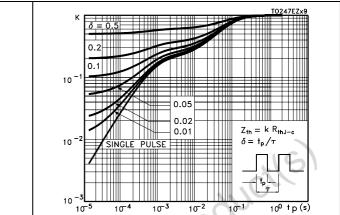
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## 2.1 Electrical characteristics (curves)

## Figure 2. Safe operating area







**Thermal impedance** 



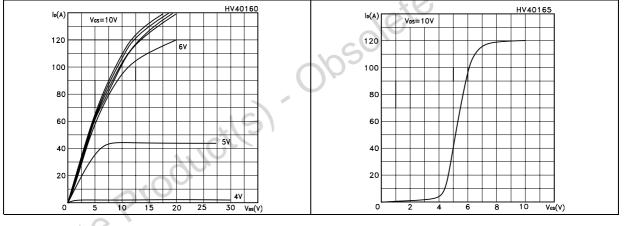
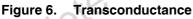
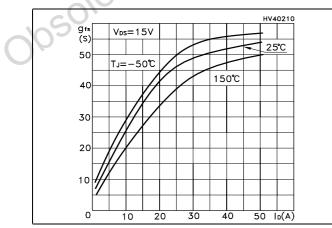
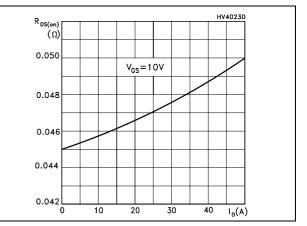


Figure 3.









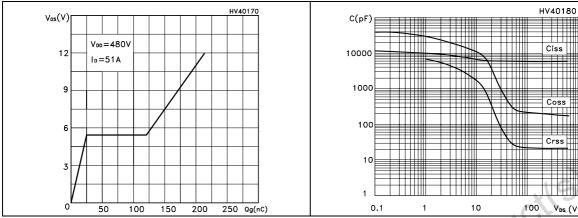
57

Ciss

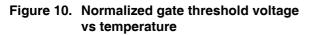
Coss

Crss

V<sub>DS</sub> (V)



#### Figure 8. Gate charge vs gate-source voltage Figure 9. **Capacitance variations**



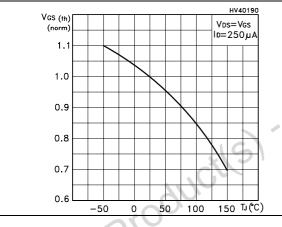
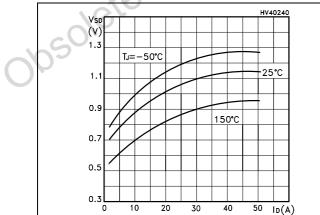
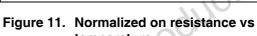


Figure 12. Source-drain diode forward characteristics







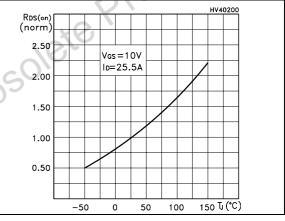
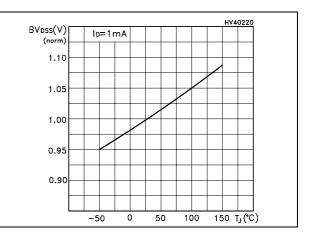
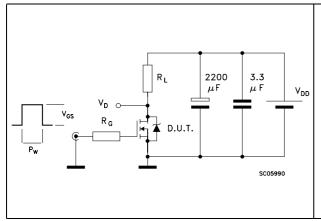


Figure 13. Normalized B<sub>VDSS</sub> vs temperature



# 3 Test circuit

Figure 14. Switching times test circuit for resistive load



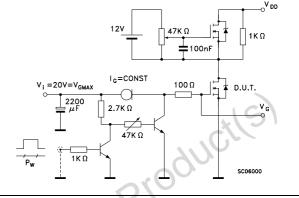
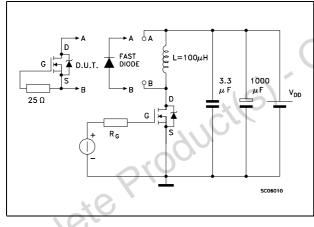


Figure 15. Gate charge test circuit

Figure 16. Test circuit for inductive load switching and diode recovery times





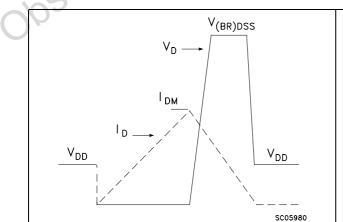


Figure 17. Unclamped inductive load test circuit

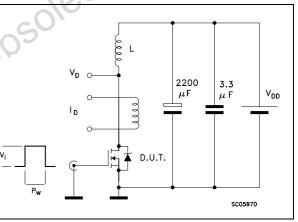
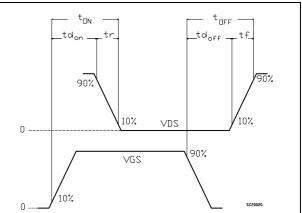


Figure 19. Switching time waveform



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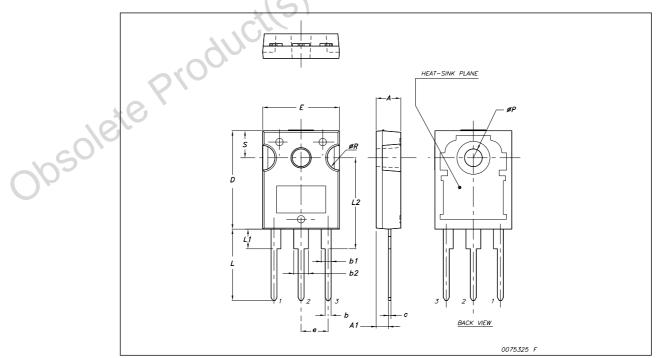
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: *www.st.com* 

obsolete Product(s). Obsolete Product(s)

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| TO-247 Mechanical data |       |       |               |  |
|------------------------|-------|-------|---------------|--|
| Dim.                   | mm.   |       |               |  |
|                        | Min.  | Тур   | Max.          |  |
| А                      | 4.85  |       | 5.15          |  |
| A1                     | 2.20  |       | 2.60          |  |
| b                      | 1.0   |       | 1.40          |  |
| b1                     | 2.0   |       | 2.40          |  |
| b2                     | 3.0   |       | 3.40 <b>C</b> |  |
| С                      | 0.40  |       | 0.80          |  |
| D                      | 19.85 |       | 20.15         |  |
| Е                      | 15.45 |       | 15.75         |  |
| е                      |       | 5.45  |               |  |
| L                      | 14.20 | × 9,  | 14.80         |  |
| L1                     | 3.70  | 10    | 4.30          |  |
| L2                     |       | 18.50 |               |  |
| øР                     | 3.55  | 103   | 3.65          |  |
| øR                     | 4.50  |       | 5.50          |  |
| S                      |       | 5.50  |               |  |



## TO-247 Mechanical data

# 5 Revision history

### Table 9.Document revision history

|                                                                                      | Date        | Revision | Changes                                                      |  |
|--------------------------------------------------------------------------------------|-------------|----------|--------------------------------------------------------------|--|
|                                                                                      | 06-Nov-2007 | 1        | Initial release                                              |  |
|                                                                                      | 19-Dec-2007 | 2        | Figure 9: Capacitance variations has been updated            |  |
|                                                                                      | 16-Jan-2008 | 3        | Document status promoted from preliminary data to datasheet. |  |
|                                                                                      | 31-Jul-2008 | 4        | E <sub>AS</sub> value has been updated in <i>Table 4</i>     |  |
| <u>31-Jul-2008</u> <u>4</u> E <sub>AS</sub> value has been updated in <i>Table 4</i> |             |          |                                                              |  |



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